

2A, 40V - 200V Schottky Barrier Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter

MECHANICAL DATA

- Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.028g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I _F	2	A
V _{RRM}	40 - 200	V
I _{FSM}	50	A
T _{J MAX}	150	°C
Package	Thin SMA	
Configuration	Single die	


 HALOGEN
FREE


Thin SMA



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

PARAMETER	SYMBOL	SS24 ALH	SS26 ALH	SS210 ALH	SS215 ALH	SS220 ALH	UNIT
Marking code on the device		24ALH	26ALH	210ALH	215ALH	220ALH	
Repetitive peak reverse voltage	V _{RRM}	40	60	100	150	200	V
Reverse voltage, total rms value	V _{R(RMS)}	28	42	70	105	140	V
Forward current	I _F			2			A
Surge peak forward current, single half sine-wave superimposed on rated load	t = 8.3ms	I _{FSM}		50			A
	t = 1.0ms			145			A
Junction temperature	T _J			-55 to +150			°C
Storage temperature	T _{STG}			-55 to +150			°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	21	°C/W
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	78	°C/W
Junction-to-case thermal resistance	$R_{\Theta JC}$	20	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ C$ unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT	
Forward voltage ⁽¹⁾	$I_F = 1A, T_J = 25^\circ C$ $I_F = 2A, T_J = 25^\circ C$ $I_F = 1A, T_J = 125^\circ C$ $I_F = 2A, T_J = 125^\circ C$	V_F	0.40	-	V	
			0.46	0.57	V	
			0.34	-	V	
			0.40	0.56	V	
	$I_F = 1A, T_J = 25^\circ C$ $I_F = 2A, T_J = 25^\circ C$ $I_F = 1A, T_J = 125^\circ C$ $I_F = 2A, T_J = 125^\circ C$		0.50	-	V	
			0.60	0.70	V	
			0.44	-	V	
			0.54	0.62	V	
	$I_F = 1A, T_J = 25^\circ C$ $I_F = 2A, T_J = 25^\circ C$ $I_F = 1A, T_J = 125^\circ C$ $I_F = 2A, T_J = 125^\circ C$		0.66	-	V	
			0.76	0.85	V	
			0.57	-	V	
			0.62	0.76	V	
	$I_F = 1A, T_J = 25^\circ C$ $I_F = 2A, T_J = 25^\circ C$ $I_F = 1A, T_J = 125^\circ C$ $I_F = 2A, T_J = 125^\circ C$		0.75	-	V	
			0.81	0.95	V	
			0.61	-	V	
			0.67	0.80	V	
	$I_F = 1A, T_J = 25^\circ C$ $I_F = 2A, T_J = 25^\circ C$ $I_F = 1A, T_J = 125^\circ C$ $I_F = 2A, T_J = 125^\circ C$		0.78	-	V	
			0.84	0.95	V	
			0.63	-	V	
			0.71	0.89	V	
Reverse current @ rated $V_R^{(2)}$	$SS24ALH$ $SS26ALH$	I_R	-	200	μA	
			-	40	mA	
	$SS210ALH$ $SS215ALH$ $SS220ALH$		-	10	μA	
			-	5	mA	
Junction capacitance	$SS24ALH$ $SS26ALH$ $SS210ALH$ $SS215ALH$ $SS220ALH$	C_J	124	-	pF	
			95	-	pF	
			61	-	pF	
			48	-	pF	
			39	-	pF	

Notes:

1. Pulse test with PW = 0.3ms
2. Pulse test with PW = 30ms

ORDERING INFORMATION

ORDERING CODE⁽¹⁾	PACKAGE	PACKING
SS2xALH	Thin SMA	14,000 / Tape & Reel

Notes:

1. "x" defines voltage from 40V(SS24ALH) to 200V(SS220ALH)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

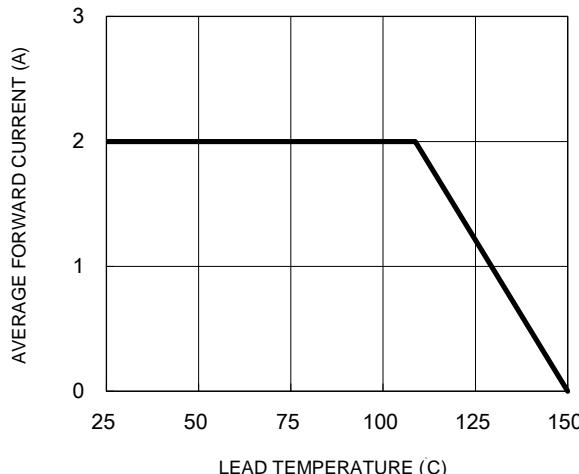


Fig.2 Typical Junction Capacitance

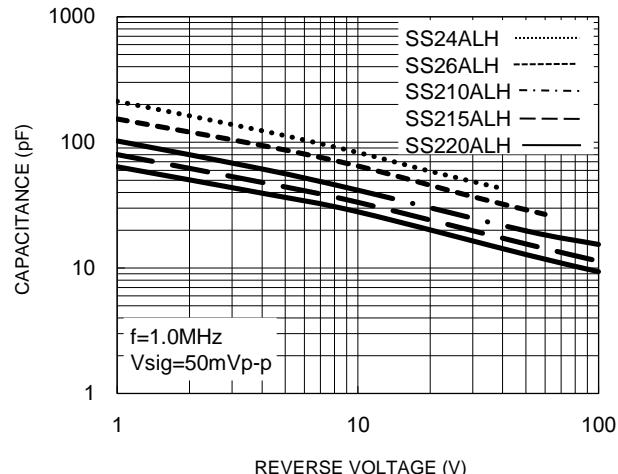


Fig.3 Typical Reverse Characteristics

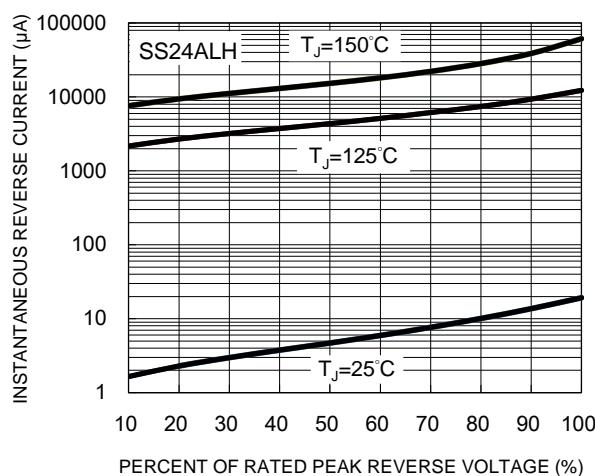


Fig.4 Typical Forward Characteristics

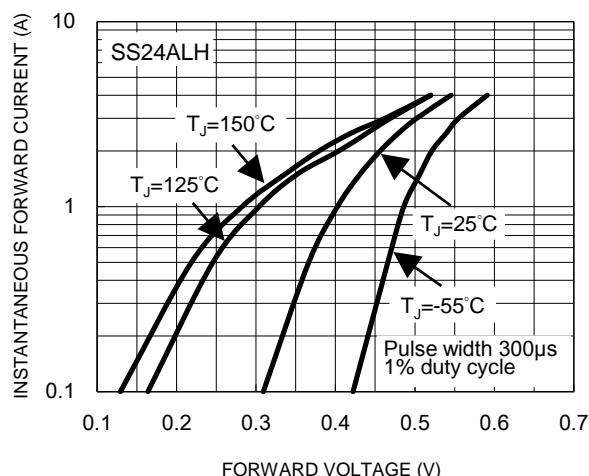


Fig.5 Typical Reverse Characteristics

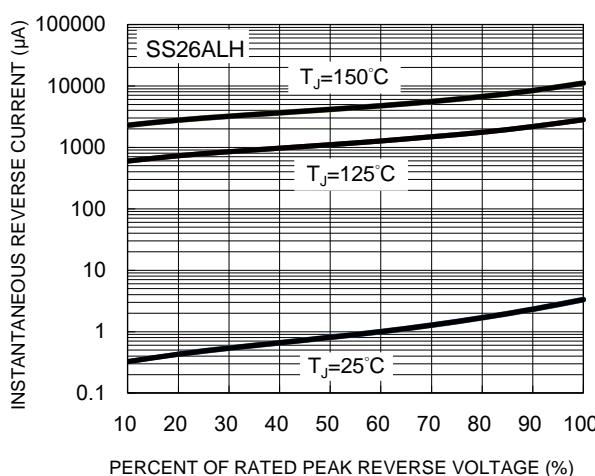
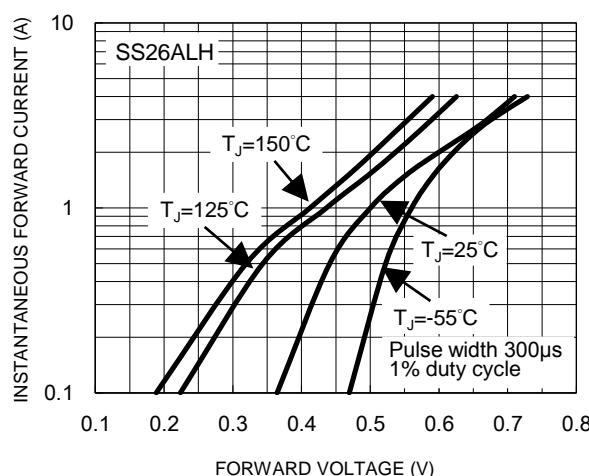


Fig.6 Typical Forward Characteristics



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.7 Typical Reverse Characteristics

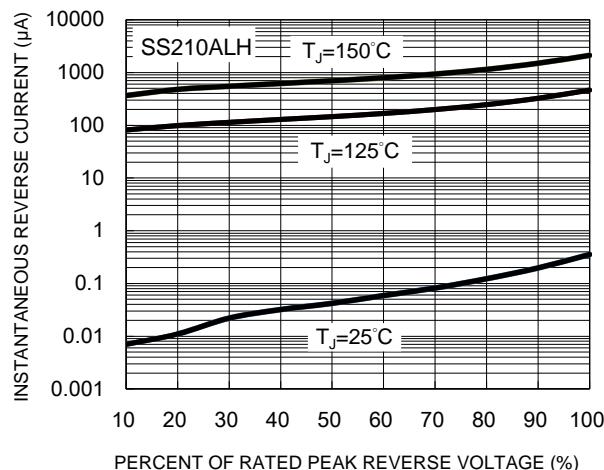


Fig.8 Typical Forward Characteristics

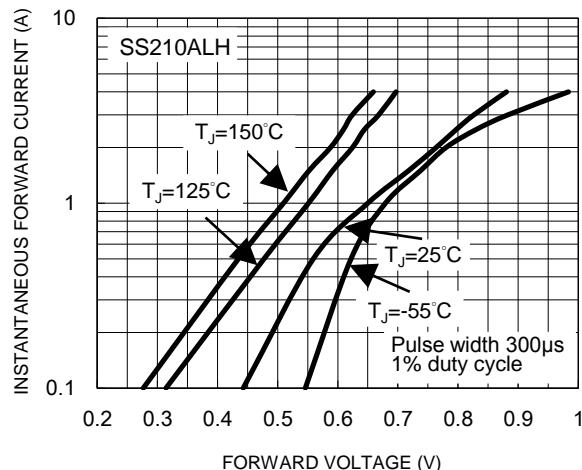


Fig.9 Typical Reverse Characteristics

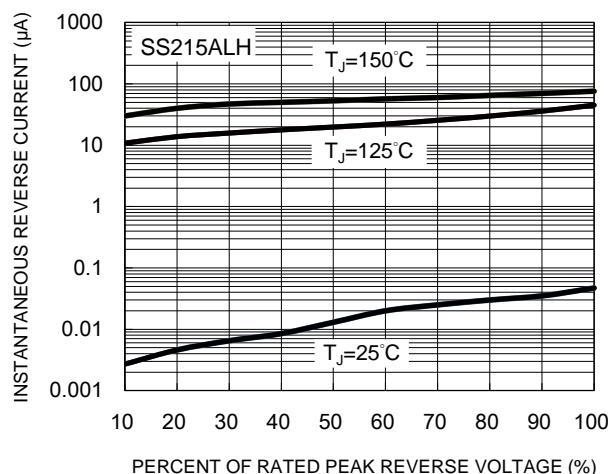


Fig.10 Typical Forward Characteristics

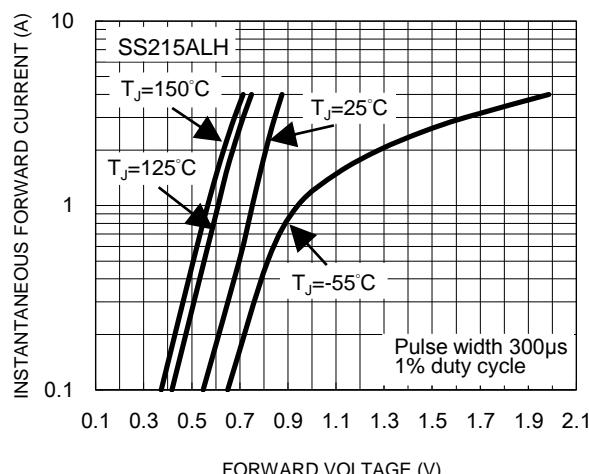


Fig.11 Typical Reverse Characteristics

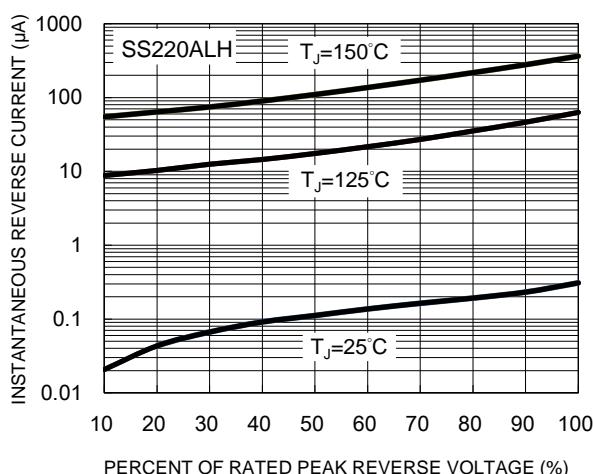
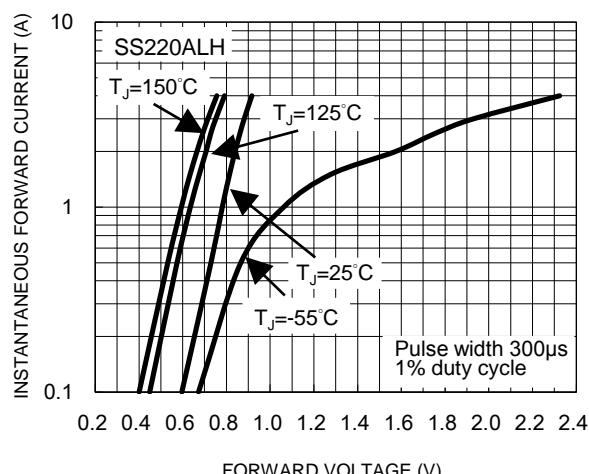
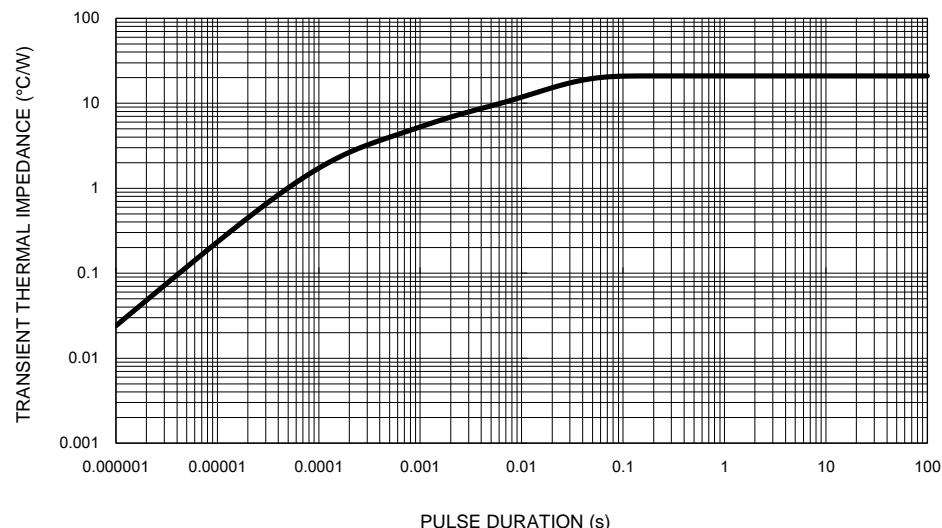


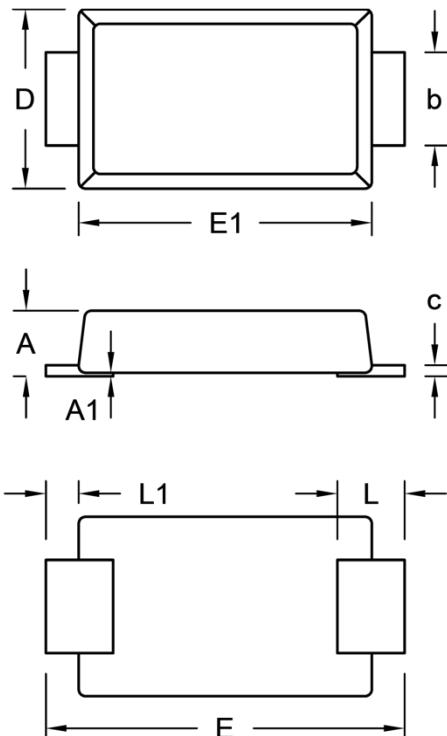
Fig.12 Typical Forward Characteristics



CHARACTERISTICS CURVES(T_A = 25°C unless otherwise noted)**Fig.13 Typical Transient Thermal Impedance**

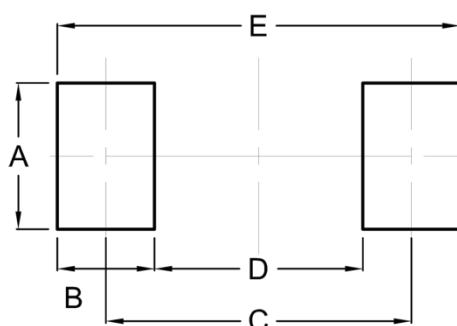
PACKAGE OUTLINE DIMENSIONS

Thin SMA



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	0.90	1.00	0.035	0.039
A1	0.00	0.10	0.000	0.004
b	1.25	1.45	0.049	0.057
c	0.10	0.22	0.004	0.009
D	2.50	2.70	0.098	0.106
E	5.05	5.35	0.199	0.211
E1	4.15	4.35	0.163	0.171
L	0.75	1.20	0.030	0.047
L1	0.30	0.60	0.012	0.024

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.10	0.083
B	1.40	0.055
C	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N = Marking Code

YWF = Date Code

F = Factory Code

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